



YOU ARE INVITED

FormFactor invites you to join us on November 18 for a virtual event presented to our users in Asia. FormFactor's COMPASS users' group conference brings together FormFactor customers from around the world to discuss the products and technologies shaping our future.



Date: November 18, 2020
Time: 9:00 - 12:30 CST (Taipei)

[Register](#)

KEYNOTE SPEAKERS



Heterogeneous Integration - An Advanced Packaging View

Hamid Azimi

Vice President Technology & Manufacturing Group, Director Substrate Packaging Technology Development, Intel Corporation



Probe in the Spotlight – A Key Enabler for Advanced Packaging, Chiplets, and Heterogenous Integration

Mike Slessor

CEO FormFactor Inc.

COMPASS VIRTUAL IS FREE
 Register early [to win great prizes*](#)

[Register](#)



AGENDA

Industry leaders and speakers from corporations, leading-edge research institutions and FormFactor share test insights on a wide variety of emerging applications, such as 5G, trends in advanced packages, and millimeter-wave measurement and calibration. Topics includes:

- The Advancement of THz Test & Measurement Equipment for 5G, 6G and Beyond (Virginia Diodes, Inc.)
- Load-pull Probe Station for Characterization of 5G Devices and Circuits at Wafer-Level
- Generation, Fine Pitch HBM Cube Testing, from Characterization to Production
- 1/f Noise Challenges and Solutions (Keysight Technologies)
- ADR Cryostats and 4 K Cryogenic Probe Stations (High Precision Devices, Inc.)
- Surface Metrology for Advanced Packaging Applications (FRT GmbH)
- 5G and mmW Applications

[Visit our website](#) for more information on these sessions and to register.

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